

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	YONG YUAN	02/04/2016
RECEIVING PARTY DATA		
Name:	SHANGHAI TIANMA MICRO-ELECTRONICS CO., LTD.	
Street Address:	889 HUIQING RD.	
Internal Address:	PUDONG NEW DISTRICT	
City:	SHANGHAI	
State/Country:	CHINA	
Postal Code:	201201	
Name:	TIANMA MICRO-ELECTRONICS CO., LTD.	
Street Address:	22/F, HANGDU BUILDING	
Internal Address:	SHENNAN ROAD, FUTIAN DISTRICT	
City:	SHENZHEN	
State/Country:	CHINA	
Postal Code:	518052	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	15019961	
CORRESPONDENCE DATA		
Fax Number:	(612)766-1600	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	612-766-7000	
Email:	amy.pirkl@faegrebd.com	
Correspondent Name:	FAEGRE BAKER DANIELS LLP	
Address Line 1:	90 SOUTH 7TH STREET	
Address Line 2:	2200 WELLS FARGO CENTER	
Address Line 4:	MINNEAPOLIS, MINNESOTA 55402	
ATTORNEY DOCKET NUMBER:	505685.000067	
NAME OF SUBMITTER:	KELSEY DEHNE	

SIGNATURE:	/kelseydehne/
DATE SIGNED:	02/11/2016
Total Attachments: 1 source=505685 000067#page1.tif	

COMBINED DECLARATION & ASSIGNMENT

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Title: TOUCH DISPLAY PANEL AND
METHOD FOR DRIVING TOUCH DISPLAY
PANEL

ASSIGNMENT

WHEREAS, I, YUAN, Yong have invented certain new and useful improvements as described in U.S. patent application, entitled **TOUCH DISPLAY PANEL AND METHOD FOR DRIVING TOUCH DISPLAY PANEL**, the application having been executed on even date herewith, and/or being identified in the United States Patent and Trademark Office ("USPTO") by Application No. 15/019,961, filed February 9, 2016, ("Invention"); and

WHEREAS, Shanghai Tianma Micro-Electronics Co., Ltd., a Corporation of the Country of Peoples' Republic of China, and having an address of 889 Huijing Rd., Pudong New District, Shanghai 201201, China; and Tianma Micro-Electronics Co., Ltd., a Corporation of the Country of Peoples' Republic of China, and having an address of 22/F, Hangdu Building, Shennan Road, Futian District, Shenzhen 518052, China (together with its successors and assigns, the "Assignee"), seeks to memorialize its ownership of the entire right, title and interest in and to the Invention;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt and adequacy of which are hereby acknowledged, I transfer to Assignee my entire right, title, and interest in and to the Invention, including all inventions disclosed or claimed in the above-identified patent application, including any improvements thereof, any corresponding domestic applications (e.g., provisional, non-provisional, divisional, continuation, continuation-in-part, reexamination, and/or reissue patent), any corresponding foreign applications, all patents issuing thereon, or other patent application based off or claiming priority to the above-identified patent application, and all rights and benefits under any applicable treaty or convention. I authorize the USPTO (or foreign equivalent thereof) to issue any patent (or similar legal protection) to the Assignee.

I authorize the Assignee to insert in this instrument the filing date and application number of the application when ascertained. I hereby authorize the Assignee (or its designee) to apply for patent (or similar legal protection) in its own name if desired, in any and all countries.

I represent to the Assignee that I have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. I agree when requested, without additional consideration, but at the expense of the Assignee, to provide additional reasonable assistance necessary to memorialize this assignment, to execute all oaths, declarations, assignments, powers of attorney and other papers necessary to perfect and vest title to the rights assigned herein to the Assignee; and will render all assistance in filing, obtaining, maintaining, and enforcing any patent (or similar legal protection) on the Invention in any and all countries.

DECLARATION

I have reviewed and understand the contents of the above-identified patent application including the claims, and I believe I am an original or an original joint inventor of a claimed invention in the above-identified patent application. The above-identified patent application was made or authorized to be made by me. I am aware of and acknowledge my duty to disclose to the USPTO all information known to me to be material to patentability of the claims in the above-identified patent application. I acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

YUAN, Yong

YUAN, Yong

Date Feb. 4, 2016